



ISO 179/1eU

ISO 179/1eA

ISO 179/1eA

ISO 2039-1

HOSTAFORM® C 27021 XAP® C HOSTAFORM®

POM copolymer

Easy flow injection molding grade with very low emissions and migrations; designed for consumer packaging. Emission according to VDA 275 < 2 mg/kg (natural grades)

Monomers and additives are listed in EU-Regulation (EU) 10/2011 FDA compliant according to 21 CFR 177.2470 FDA = Food and Drug Administration (USA)

Product information

| Product information | | | |
|-----------------------------------|-------|------------------------|-----------------|
| Resin Identification | POM | | ISO 1043 |
| Part Marking Code | >POM< | | ISO 11469 |
| Rheological properties | | | |
| Melt volume-flow rate | 24 | cm ³ /10min | ISO 1133 |
| Temperature | 190 | °C | |
| Load | 2.16 | kg | |
| Moulding shrinkage, parallel | 1.9 | % | ISO 294-4, 2577 |
| Moulding shrinkage, normal | 1.8 | % | ISO 294-4, 2577 |
| Typical mechanical properties | | | |
| Tensile modulus | 2900 | MPa | ISO 527-1/-2 |
| Tensile stress at yield, 50mm/min | 65 | MPa | ISO 527-1/-2 |
| Tensile strain at yield, 50mm/min | 7.5 | % | ISO 527-1/-2 |
| Nominal strain at break | 17 | % | ISO 527-1/-2 |
| Flexural modulus | 2800 | MPa | ISO 178 |
| Tensile creep modulus, 1h | 2500 | MPa | ISO 899-1 |
| Tensile creep modulus, 1000h | 1300 | MPa | ISO 899-1 |
| Charpy impact strength, 23°C | 170 | kJ/m² | ISO 179/1eU |
| | | | |

Charpy notched impact strength, -30 °C Ball indentation hardness, H 358/30

Charpy impact strength, -30°C

Charpy notched impact strength, 23°C

Poisson's ratio [C]: Calculated

Thermal properties

| Melting temperature, 10 ° C/min 166 | °C ISO 11357-1/-3 |
|---|----------------------|
| Temperature of deflection under load, 1.8 MPa 106 | °C ISO 75-1/-2 |
| Coefficient of linear thermal expansion 110 | E-6/K ISO 11359-1/-2 |
| (CLTE), parallel | |
| Thermal conductivity of melt 0.155 | W/(m K) ISO 22007-2 |
| Specific heat capacity of melt 2210 | J/(kg K) ISO 22007-4 |

170 kJ/m²

5.5 kJ/m²

 5.5 kJ/m^2

147 MPa

0.37^[C]

Flammability

| Burning Behav. at 1.5mm nom. thickn. | HB | class | IEC 60695-11-10 |
|--------------------------------------|-----|-------|-----------------|
| Thickness tested | 1.5 | mm | IEC 60695-11-10 |
| Burning Behav. at thickness h | HB | class | IEC 60695-11-10 |
| Thickness tested | 3 | mm | IEC 60695-11-10 |
| UL recognition | yes | | UL 94 |

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Electrical properties

| Relative permittivity, 100Hz | 4 | IEC 62631-2-1 |
|------------------------------|------------|---------------|
| Relative permittivity, 1MHz | 4 | IEC 62631-2-1 |
| Dissipation factor, 100Hz | 25 E-4 | IEC 62631-2-1 |
| Dissipation factor, 1MHz | 50 E-4 | IEC 62631-2-1 |
| Volume resistivity | 1E12 Ohm.m | IEC 62631-3-1 |
| Surface resistivity | 1E14 Ohm | IEC 62631-3-2 |
| Electric strength | 35 kV/mm | IEC 60243-1 |
| Comparative tracking index | 600 | IEC 60112 |

Physical/Other properties

| Humidity absorption, 2mm | 0.2 % | Sim. to ISO 62 |
|--------------------------|------------------------|----------------|
| Water absorption, 2mm | 0.65 % | Sim. to ISO 62 |
| Density | 1410 kg/m ³ | ISO 1183 |

Injection

| Drying Recommended | no | |
|---------------------------------|----------|-----|
| Drying Temperature | 100 | °C |
| Drying Time, Dehumidified Dryer | 3 - 4 | h |
| Processing Moisture Content | ≤0.2 | % |
| Melt Temperature Optimum | 200 | °C |
| Min. melt temperature | 190 | °C |
| Max. melt temperature | 210 | °C |
| Screw tangential speed | ≤0.3 | m/s |
| Mold Temperature Optimum | 100 | °C |
| Min. mould temperature | 80 | °C |
| Max. mould temperature | 120 | °C |
| Hold pressure range | 60 - 120 | MPa |
| Back pressure | 4 | MPa |
| Ejection temperature | 140 | °C |

Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent Special characteristics Low emissions

Additional information

Injection molding Preprocessing

To achive low emission values pre drying using a recirculating air dryer (100 to $120 \, ^{\circ}\text{C}$ / max. 40 mm layer / 3 to 6 hours) is recommended.

Max. Water content 0,1 %

Processing

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Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes

Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Storage

The product can then be stored in standard conditions until processed.

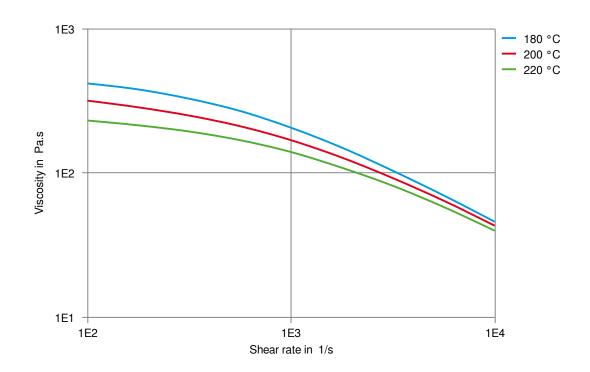
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Viscosity-shear rate

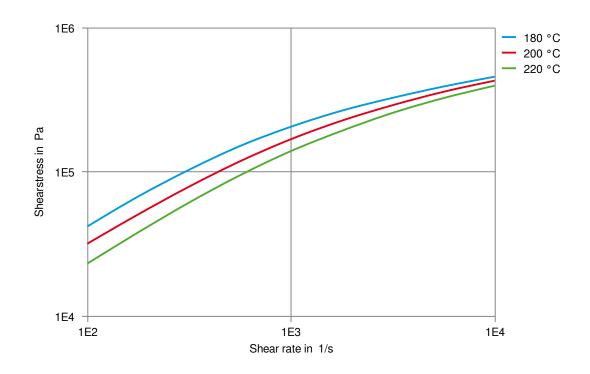


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Shearstress-shear rate

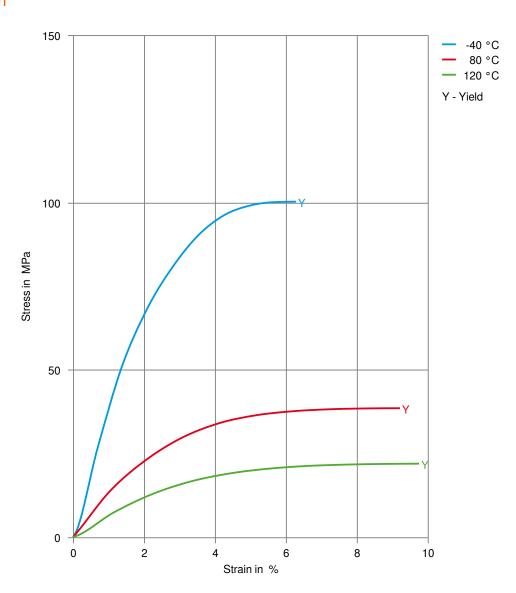


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Stress-strain



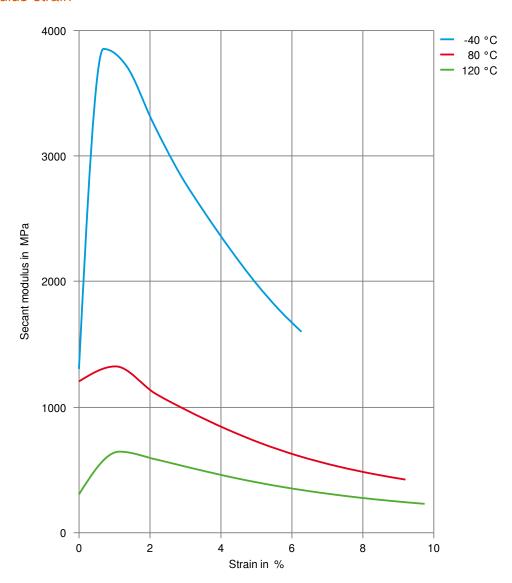
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HOSTAFORM® C 27021 XAP® C

Secant modulus-strain



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